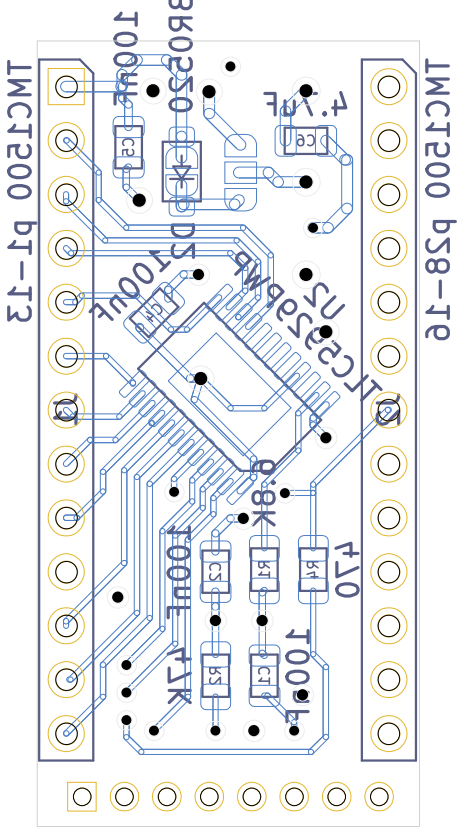

BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	1.6000 mm
Board overall dimensions:	18.0000 mm x 37.0000 mm		
Min track/spacing:	0.2000 mm / 0.2000 mm	Min hole diameter:	0.2000 mm
Copper Finish:	None	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		